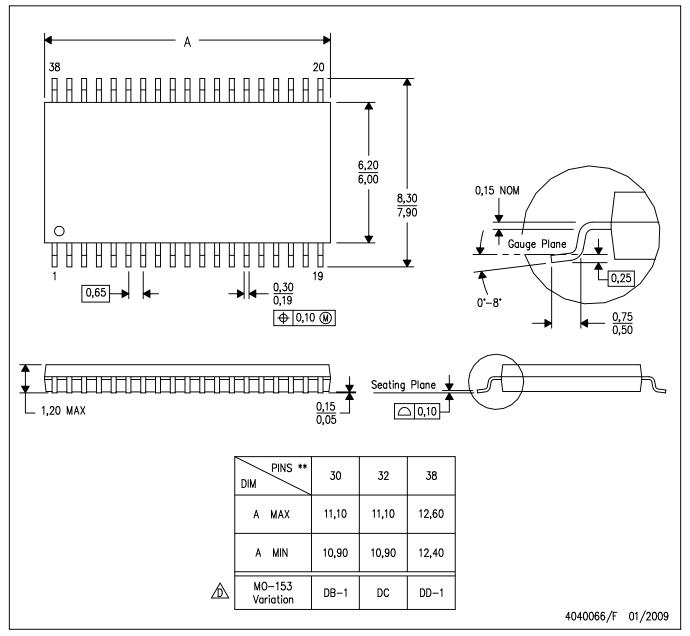
DA (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

38 PIN SHOWN



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
- ⚠ Falls within JEDEC MO−153, except 30 pin body length.



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